

SOT38-4

plastic dual in-line package; 16 leads (300 mil) 8 February 2016

Package information

1. Package summary

Terminal position code D (double)

DIP16 Package type descriptive code DIP16 Package type industry code

Package style descriptive code DIP (dual in-line package)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

Mounting method type T (through-hole mount)

Issue date 13-2-2003

Table 1. Package summary

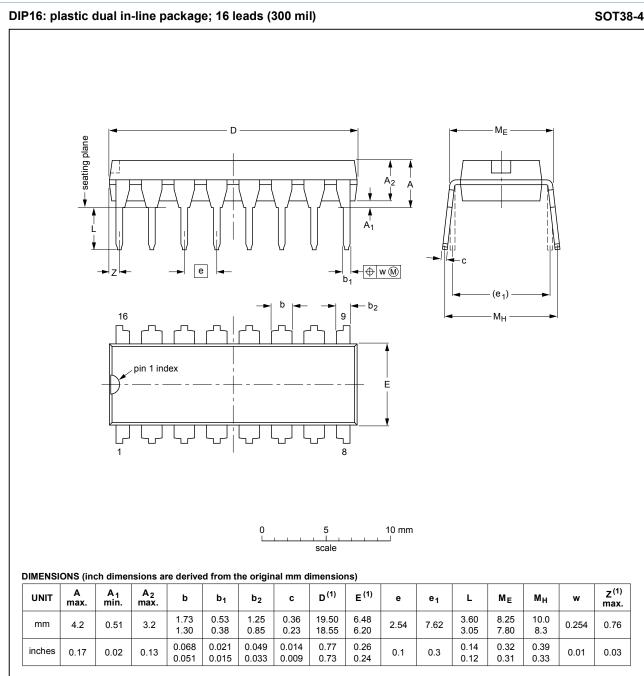
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	18.55	-	19.03	19.5	mm
E	package width	6.2	-	6.35	6.48	mm
Α	seated height	[tbd]	-	4.2	4.2	mm
A ₂	package height	[tbd]	-	3.04	3.2	mm
n ₂	actual quantity of termination	-	-	16	-	



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2. Package outline



Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT38-4						95-01-14 03-02-13

Fig. 1. Package outline DIP16 (SOT38-4)

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3. Legal information

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